© Copyr	ial Composition ight 2005. IPC, Banno onal and Pan-America	ockburn, Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declara he declaration	tion of the encompass	substances ses all low	s within the manufact er level materials for	urer listed which the	item. Note: nanufacture	if the item is an as r has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribut				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					erials and N	als and Mfg Information			
Supplier Information														
Company name* Co			Company unique ID			Unique ID Authority				Respor	Response Date*			
onsemi										2025-0	2025-05-11			
Contact Name Title - Co			- Contact			Phone - Contact*				Email ·	Email - Contact*			
Product-Env-Stewards Produc			roduct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - I			e - Representative			Phone - Representative*			Email ·	Email - Representative*				
Product-Env-Stewards Pro			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Item		Item Number	Number Mfr Item Name			Effective Dat	e Versio	n	Manufacturing Site		Weight*	UOM	Unit Type	
	MM	MM3Z24VC 24.0V		24.0V 0.2W 5% Zen SOD323F		2025-05-11			CN2		4.58939	mg	Each	
Manufacturing Proccess	Information						·							
Terminal Plating / Grid Array Material Terminal Base		Alloy	J-STD-020 MSI	Rating	Peak Pro	cess Body	Temperati	re Max Time at Pea	ık Tempera	ture Num	ber of Reflow Cy	cles		
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30	seco	nds 3			
Comments														
level 1 - maximum time at peak	k temperature during	g soldering is 10-3	0 seconds											
For more information regardin	ng material composit	ion please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter a [F] Optionally enter the positive (+) and n				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.03	mg	Supplier	Silicon (Si)	7440-21-3		0.0285	mg
			Supplier	Gold (Au)	7440-57-5		0.0014	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0001	mg
Lead Frame	1.004	mg	Supplier	Silver (Ag)	7440-22-4		0.004	mg
			Supplier	Chromium (Cr)	7440-47-3		0.002	mg
			Supplier	Manganese (Mn)	7439-96-5		0.008	mg
			В	Nickel (Ni)	7440-02-0		0.41	mg
			Supplier	Iron (Fe)	7439-89-6		0.58	mg
Mold Compound-Black	3.44999	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.3736	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0186	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		2.7179	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.3398	mg
Plating	0.1	mg	Supplier	Tin (Sn)	7440-31-5		0.1	mg
Wire Bond - Cu	0.0054	mg	Supplier	Copper (Cu)	7440-50-8		0.0054	mg